

6N135, 6N136, CT4502, CT4503

1Mbit/s High Speed Phototransistor Optocoupler

Features

- High speed 1MBit/s
- High isolation voltage between input and output (Viso=5000 Vrms)
- Guaranteed CTR performance from 0 °C to 70 °C
- Wide operating temperature range of -55 ℃ to 100 ℃
- Regulatory Approvals
 - UL UL1577 (E364000)
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - IEC60065, IEC60950

Applications

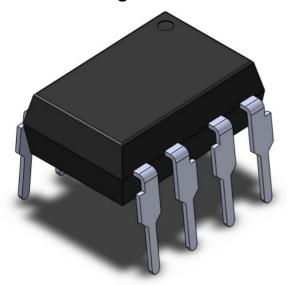
- Line receivers
- Telecommunication equipment
- High speed logic ground isolation
- Feedback loop in switch-mode power supplies
- Home appliances

Description

The 6N135, 6N136, CT4502 and CT4503 devices each consist of an infrared emitting diode, optically coupled to a high speed photo detector transistor. A separate connection for the photodiode bias and output-transistor collector increase the speed by several orders of magnitude over conventional phototransistor couplers by reducing the base-collector capacitance of the input transistor.

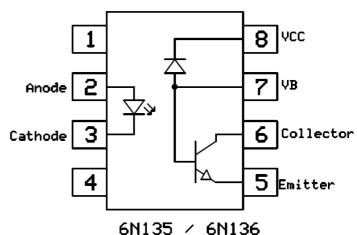
The devices are packaged in an 8-pin DIP package and also available in gullwing (400mil) and surface mount lead forming.

Package Outline



Note: Different bending options available. See package dimension.

Schematic



Pin 7 not connected for CT4502/CT4503



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage *1	5000	V _{RMS}	
Topr	Operating temperature	-55 ~ +100	°C	
Тѕтс	Storage temperature	-55 ~ +125	°C	
Tsol	Soldering temperature *2	260	°C	
Emitter			<u> </u>	
lF	Forward current	25	mA	
I _{FP}	Peak forward current (50% duty, 1ms P.W)	50	mA	
I _{F(TRANS)}	Peak transient current (≤1µs P.W,300pps)	1	А	
V _R	Reverse voltage	5	V	
PD	Power dissipation	40	mW	
Detector			<u> </u>	
PD	Power dissipation	100	mW	
V _{EBR}	Emitter-Base reverse voltage	5	V	
lв	Base current	5	mA	
I _{O(AVG)}	Average Output current	8	mA	
I _{O (Peak)}	Peak Output current	16	mA	
Vo	Output voltage	-0.5 to 20	V	
Vcc	Supply voltage	-0.5 to 30	V	



Electrical Characteristics

 T_A = 0 - 70 °C (unless otherwise specified). Typical values are measured at T_A = 25°C and V_{CC} =5V

Emitter Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 16mA	-	1.45	1.6	V	
VR	Reverse Voltage	IR = 10μA	5.0	-	-	V	
$\Delta V_F/\Delta T_A$	Temperature coefficient of forward voltage	IF =16mA	-	-1.8	-	mV/℃	

Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
	Logic High Output Current	I _F =0mA, V _O =V _{CC} =5.5V,		0.001	0.5	μА	
		T _A =25 ℃	-				
Іон		I _F =0mA, V _O =V _{CC} =15V,		0.01	1		
		T _A =25 ℃	-				
		I _F =0mA, V _O =V _{CC} =15V	-	-	50		
ICCL	Logic Low Supply Current	I _F =16mA, V _O =Open,	1	140	200	μА	
ICCL		V _{CC} =15V					
	Logic High Supply Current	I _F =0mA, V _O =Open, V _{CC} =15V,		0.01	1		
Іссн		T _A =25 ℃	-			^	
ICCH		IF=0mA, VO=Open,	_		2	μΑ	
		VCC=15V	-	_			



Electrical Characteristics

 T_A = 0 - 70 °C (unless otherwise specified). Typical values are measured at T_A = 25°C and V_{CC} =5V

Transfer Characteristics

Symbol	Paramete	ers	Test Conditions	Min	Тур	Max	Units	Notes
		6N135		7	-	50		
		6N136	$I_F=16mA, V_O=0.4V, V_{CC}=4.5V,$					
		CT4502	T _A =25 ℃	19	-	50		
CTR	Current Transfer	CT4503					%	
CIN	Ratio	6N135		5	-	-	70	
		6N136	10mA \/ 0.E\/ \/ 4.E\/	15]	
		CT4502	$I_F=16mA$, $V_O=0.5V$, $V_{CC}=4.5V$					
		CT4503						
	Logic Low Output CT4: Voltage 6N1: CT4:	CNIADE	I _F =16mA,I _O =1.1mA,V _{CC} =4.5V,	-	0.10	0.4		
		601135	T _A =25℃		0.18			
		6N136	I _F =16mA, I _O =3mA, V _{CC} =4.5V,					
		CT4502	T _A =25 ℃	-	0.18	0.4		
V_{OL}		CT4503	= 0				V	
- 02		6N135	I _F =16mA, I _O =0.8mA,	_	_	0.5		
			Vcc=4.5V					
		6N136	I _F =16mA, I _O =2.4mA,	-	-	0.5		
		CT4502	V _{CC} =4.5V					
		CT4503	- 00- 110 V					



Electrical Characteristics

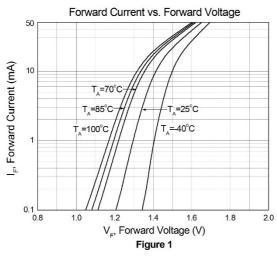
 T_A = 0 - 70 °C (unless otherwise specified). Typical values are measured at T_A = 25°C and V_{CC} =5V

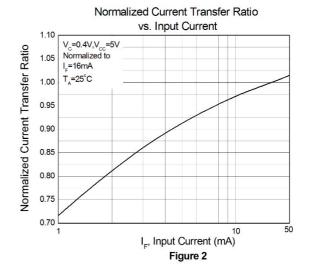
Switching Characteristics

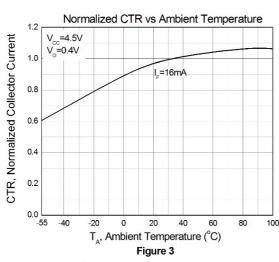
Symbol	Paramete	ers	Test Conditions	Min	Тур	Max	Units	Notes
	Propagation Delay	6N135	R _L =4.1KΩ, T _{A=} 25℃	-	0.35	1.5		
		ONTO	R _L =4.1KΩ	-	-	2.0		
T _{PHL}	Time Logic High to Logic Low	6N136	R _L =1.9KΩ, T _A =25℃	-	0.35	0.8	μs	
	Logic Low	CT4502 CT4503	R _L =1.9KΩ	-	-	1.0		
	Draw a setion Dalay	CNITOE	R _L =4.1KΩ, T _{A=} 25℃	-	0.5	1.5		
	Propagation Delay	6N135	R _L =4.1KΩ	-	-	2.0		
T_PLH	Time Logic Low to Logic High	6N136	R _L =1.9KΩ, T _A =25℃	-	0.3	0.8	μs	
	Logic High	CT4502 CT4503	R _L =1.9KΩ	-	-	1.0		
	Common Mode Transient Immunity at Logic High	6N135 $ \begin{aligned} I_F &= 0 mA \text{ , } V_{CM} = 10 Vp-p, \\ R_L &= 4.1 K\Omega, T_A = 25 ^{\circ}\text{C} \end{aligned} $	1 000					
			R _L =4.1KΩ, T _A =25℃	1,000	-	-		
СМн		6N136	$I_F = 0mA$, $V_{CM}=10Vp-p$,	1.000	_		V/µs	
CIVIH		CT4502	R _L =1.9KΩ, T _A =25°C	1,000	-	,	ν/μδ	
		CT4503	I _F = 0mA , V _{CM} =1500Vp-p,	15,000	20,000			
		014303	R _L =1.9KΩ, T _A =25 ℃	13,000	20,000			
		6N135	$I_F = 16mA$, $V_{CM}=10Vp-p$,	1,000	_	-		
CML	Common Mode Transient Immunity at Logic Low		R _L =4.1KΩ, T _A =25℃		_			
		6N136	$I_F = 16mA$, $V_{CM}=1500Vp-p$,	1,000	00		V/µs	
OIVIL		CT4502	R _L =1.9KΩ, T _A =25°C		-	-	ν/μδ	
		CT4503	$I_F = 16mA$, $V_{CM}=1500Vp-p$,	15,000	20,000			
			R _L =1.9KΩ, T _A =25℃		20,000			

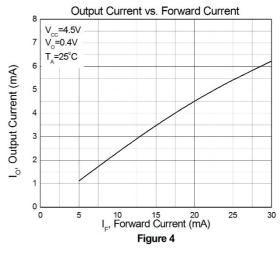


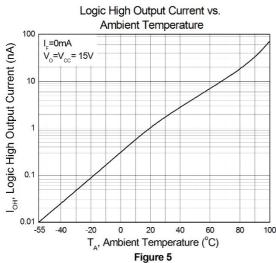
Typical Characteristic Curves

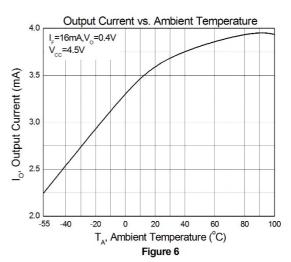




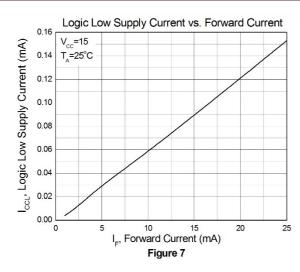


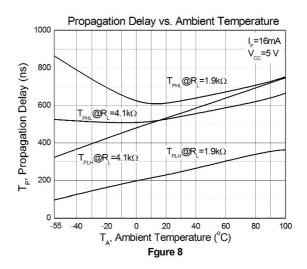


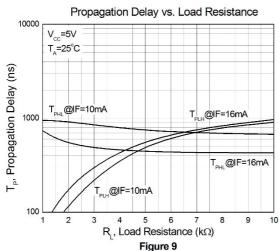






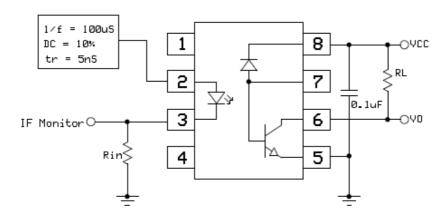


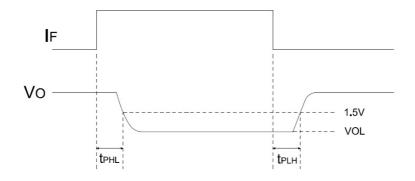






Test Circuits

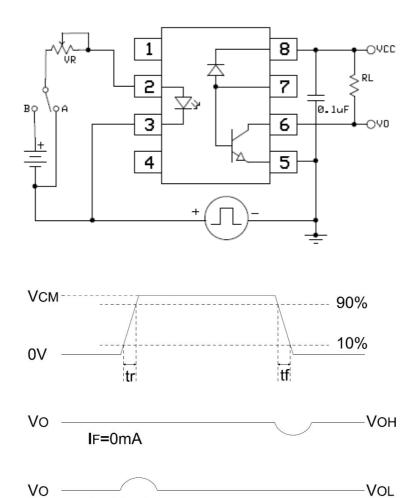




Switching Time Test Circuit



Test Circuits



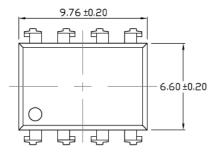
CMR Test Circuit

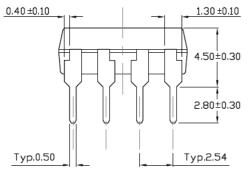
IF=16mA

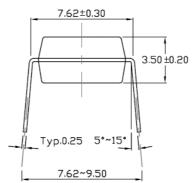


Package Dimension Dimensions in mm unless otherwise stated

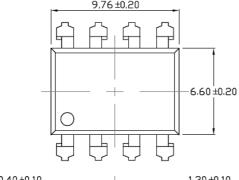
Standard DIP - Through Hole

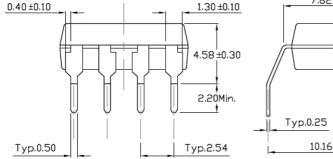


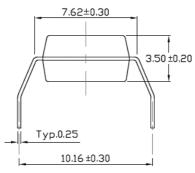




Gullwing (400mil) Lead Forming – Through Hole (M Type)

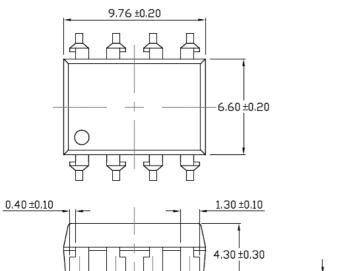


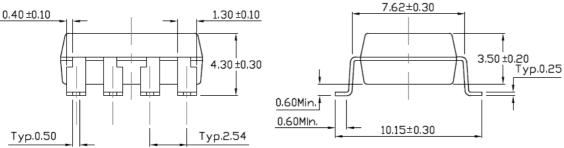




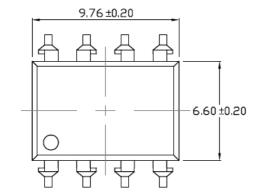


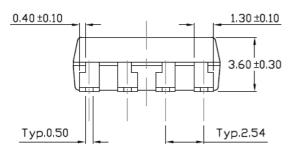
Surface Mount Lead Forming (S Type)

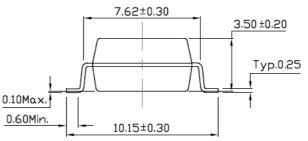




Surface Mount (Low Profile) Lead Forming (SL Type)

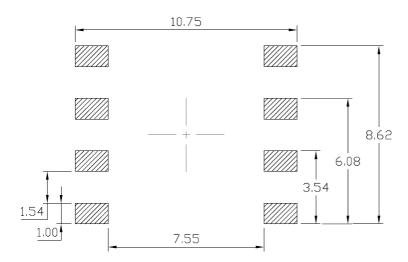




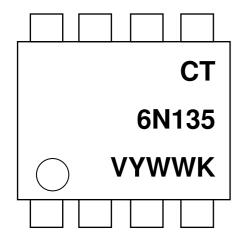


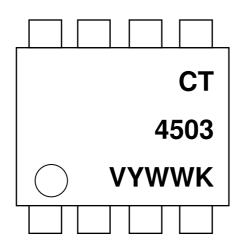


Recommended Solder Mask Dimensions in mm unless otherwise stated



Device Marking





CT: Denotes "CT Micro"
6N135: Product Number
V: VDE Option
Y: Fiscal Year
WW: Work Week

K : Production Code



Ordering Information

6N13X(V)(Y)(Z) or CT450X(V)(Y)(Z)

X = Part No. (5,6 for 6N13X series), (2,3 for CT450X series)

V = VDE Option (V or None)

Y = Lead form option (S, SL, M or none)

Z = Tape and reel option (T1, T2 or none)

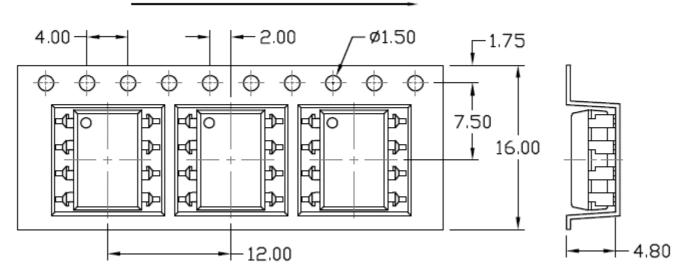
Option	Option Description	
None	None Standard 8 Pin Dip	
М	Gullwing (400mil) Lead Forming	40 Units/Tube
S(T1)	Surface Mount Lead Forming – With Option 1 Taping	1000 Units/Reel
S(T2)	Surface Mount Lead Forming – With Option 2 Taping	1000 Units/Reel
SL(T1)	Surface Mount (Low Profile) Lead Forming- With Option 1 Taping	1000 Units/Reel
SL(T2)	Surface Mount (Low Profile) Lead Forming- With Option 2 Taping	1000 Units/Reel



Carrier Tape Specifications Dimensions in mm unless otherwise stated

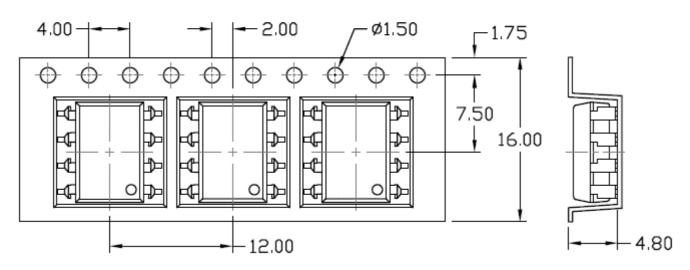
Option S(T1) & SL(T1)

Input Direction



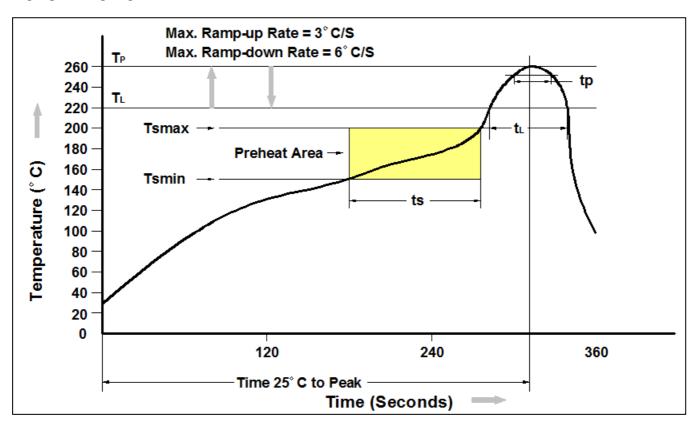
Option S(T2) & SL(T2)

Input Direction





Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150℃
Temperature Max. (Tsmax)	200℃
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t _L to t _P)	3 ℃/second max.
Liquidous Temperature (T _L)	217℃
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260℃ +0℃ / -5℃
Time (t _P) within 5 °C of 260 °C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25 ℃ to Peak Temperature	8 minutes max.



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- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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